MOSFET – Power, Dual N-Channel 60 V, 6.5 mΩ, 68 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFD5C668NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

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Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	٧
Gate-to-Source Voltage	Э		V _{GS}	±20	٧
Continuous Drain		T _C = 25°C	I _D	68	Α
Current R _{0JC} (Notes 1, 2, 3)	Steady	T _C = 100°C		48	
Power Dissipation	State	T _C = 25°C	P_{D}	57.5	W
R _{θJC} (Notes 1, 2)		T _C = 100°C		29	
Continuous Drain		T _A = 25°C	I _D	15.5	Α
Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C		11	
Power Dissipation	State	$T_A = 25^{\circ}C$ P_D		3.0	W
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.5	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	454	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to + 175	°C
Source Current (Body Diode)			I _S	48	Α
Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, I _{L(pk)} = 3.22 A)			E _{AS}	205	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.6	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	50.26	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

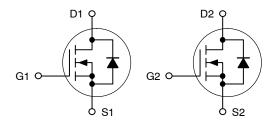


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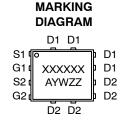
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	6.5 mΩ @ 10 V	CO A
	9.2 mΩ @ 4.5 V	68 A

Dual N-Channel







XXXXXX = 5C668L (NVMFD5C668NL) or 668LWF (NVMFD5C668NLWF)

A = Assembly Location

Y = Year W = Work Week ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				28		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	T _J = 25°C			10		
		$V_{DS} = 60 \text{ V}$	T _J = 125°C			250	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS}$	s = 20 V			100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 50 μΑ	1.2		2.0	V	
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.3		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A		5.4	6.5	_	
		V _{GS} = 4.5 V	I _D = 20 A		7.4	9.2	mΩ	
Forward Transconductance	9FS	V _{DS} = 15 V, I _D	= 20 A		61		S	
CHARGES, CAPACITANCES & GATE RESIS	TANCE				•			
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1440			
Output Capacitance	C _{OSS}				800		pF	
Reverse Transfer Capacitance	C _{RSS}				14			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 20 A			9.8			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 20 A			21.3		1	
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 20 A			2.5		nC	
Gate-to-Source Charge	Q _{GS}				4.3			
Gate-to-Drain Charge	Q_{GD}				2.1			
Plateau Voltage	V_{GP}				2.9		V	
SWITCHING CHARACTERISTICS (Note 5)								
Turn-On Delay Time	t _{d(ON)}				10			
Rise Time	t _r	V _{GS} = 10 V, V _{DS}	a = 48 V.		22		ns ns	
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 20 \text{ A}, R_G =$	= 1.0 Ω		40			
Fall Time	t _f				7.0		1	
DRAIN-SOURCE DIODE CHARACTERISTIC	s							
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V,	T _J = 25°C		0.85	1.2	'	
		$I_S = 20 \text{ A}$	T _J = 125°C		0.73		V	
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, dIS/dt} = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 20 \text{ A}$			42			
Charge Time	t _a				20		ns	
Discharge Time	t _b				22		1	
Reverse Recovery Charge	Q _{RR}				32		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

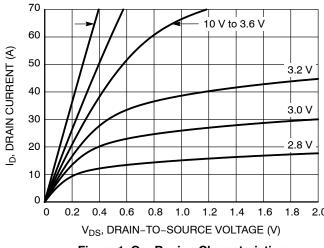


Figure 1. On-Region Characteristics

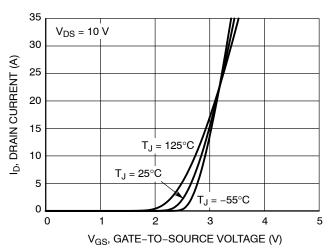


Figure 2. Transfer Characteristics

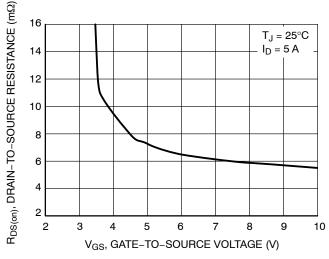


Figure 3. On-Resistance vs. Gate-to-Source Voltage

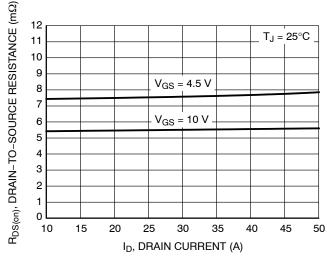


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

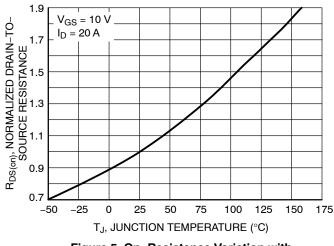


Figure 5. On–Resistance Variation with Temperature

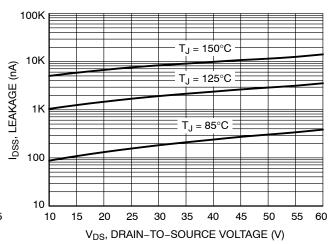


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS

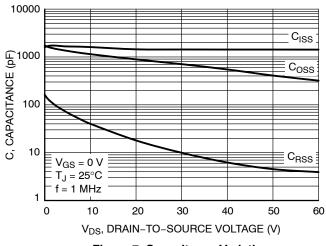


Figure 7. Capacitance Variation

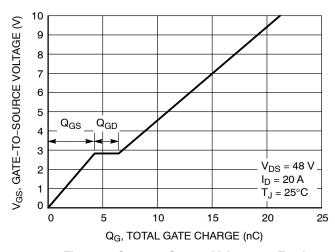
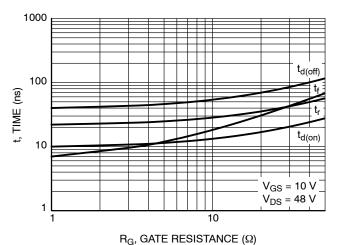


Figure 8. Gate-to-Source Voltage vs. Total Charge



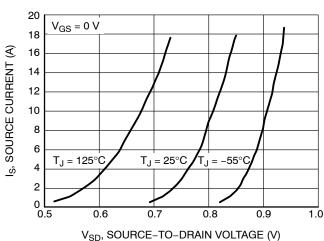


Figure 10. Diode Forward Voltage vs. Current



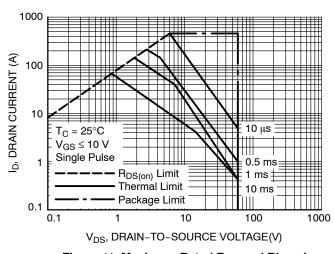


Figure 11. Maximum Rated Forward Biased Safe Operating Area

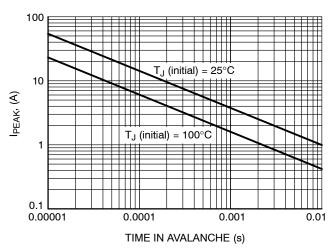


Figure 12. I_{PEAK} vs. Time in Avalanche

TYPICAL CHARACTERISTICS

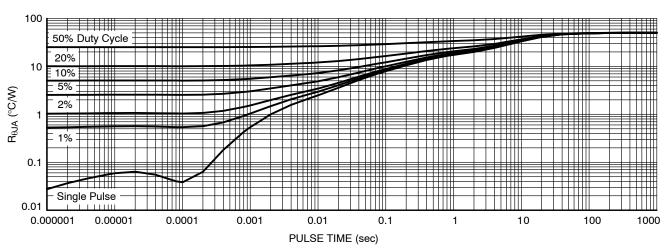


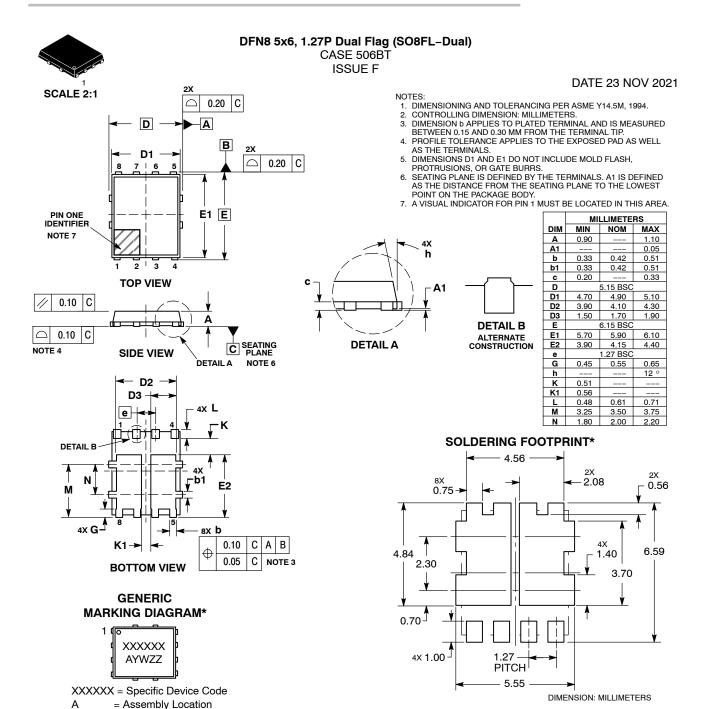
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFD5C668NLT1G	5C668L	DFN8 (Pb-Free)	1500 / Tape & Reel
NVMFD5C668NLWFT1G	668LWF	DFN8 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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= Year

not follow the Generic Marking.

= Work Week

= Lot Traceability *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may

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*For additional information on our Pb-Free strategy and soldering

Mounting Techniques Reference Manual, SOLDERRM/D.

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